## CONNECTION DEVICE AND METHOD OF FORMING A CONNECTION DEVICE

## 5 ABSTRACT OF THE DISCLOSURE

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A connection device includes a plurality of re-configurable vias that connect a first metal layer to a second metal layer. An actuating element is disposed between the first metal layer and the second metal layer. The actuating element changes the configuration of the plurality of re-configurable vias to change the plurality of re-configurable vias between a conductive state and a non-conductive state.